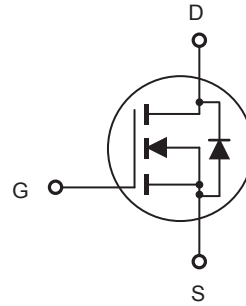
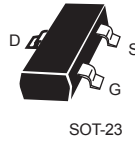


## N-Channel Enhancement Mode Field Effect Transistor

### FEATURES

- 30V, 4.8A,  $R_{DS(ON)} = 34m\Omega$  @ $V_{GS} = 10V$ .  
 $R_{DS(ON)} = 38m\Omega$  @ $V_{GS} = 4.5V$ .  
 $R_{DS(ON)} = 50m\Omega$  @ $V_{GS} = 2.5V$ .  
 $R_{DS(ON)} = 60m\Omega$  @ $V_{GS} = 1.8V$ .
- High dense cell design for extremely low  $R_{DS(ON)}$ .
- Rugged and reliable.
- Lead-free plating ; RoHS compliant.
- SOT-23 package.



### ABSOLUTE MAXIMUM RATINGS $T_A = 25^\circ C$ unless otherwise noted

| Parameter                             | Symbol         | Limit      | Units      |
|---------------------------------------|----------------|------------|------------|
| Drain-Source Voltage                  | $V_{DS}$       | 30         | V          |
| Gate-Source Voltage                   | $V_{GS}$       | $\pm 12$   | V          |
| Drain Current-Continuous              | $I_D$          | 4.8        | A          |
| Drain Current-Pulsed <sup>a</sup>     | $I_{DM}$       | 20         | A          |
| Maximum Power Dissipation             | $P_D$          | 1.25       | W          |
| Operating and Store Temperature Range | $T_J, T_{stg}$ | -55 to 150 | $^\circ C$ |

### Thermal Characteristics

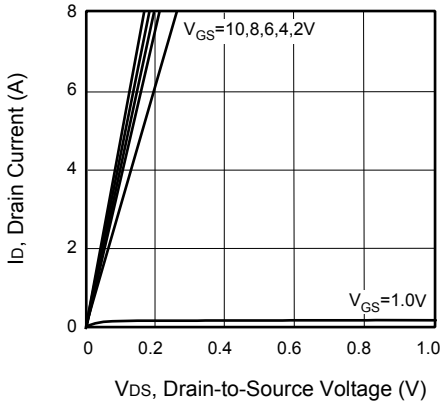
| Parameter  | Symbol          | Limit | Units        |
|--|-----------------|-------|--------------|
| Thermal Resistance, Junction-to-Ambient <sup>b</sup> | $R_{\theta JA}$ | 100   | $^\circ C/W$ |



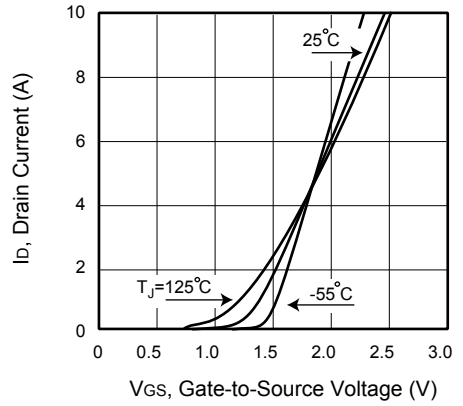
# CES2310

## Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

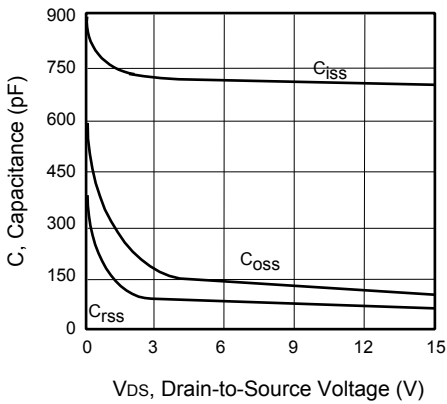
| Parameter  | Symbol       | Test Condition   | Min | Typ | Max  | Units     |
|--|--------------|--|-----|-----|------|-----------|
| <b>Off Characteristics</b>   |              |  |     |     |      |           |
| Drain-Source Breakdown Voltage   | $BV_{DSS}$   | $V_{GS} = 0V, I_D = 250\mu A$  | 30  |     |      | V         |
| Zero Gate Voltage Drain Current  | $I_{DSS}$    | $V_{DS} = 30V, V_{GS} = 0V$  |     |     | 1    | $\mu A$   |
| Gate Body Leakage Current, Forward   | $I_{GSSF}$   | $V_{GS} = 12V, V_{DS} = 0V$  |     |     | 100  | nA        |
| Gate Body Leakage Current, Reverse   | $I_{GSSR}$   | $V_{GS} = -12V, V_{DS} = 0V$   |     |     | -100 | nA        |
| <b>On Characteristics <sup>c</sup></b>   |              |  |     |     |      |           |
| Gate Threshold Voltage   | $V_{GS(th)}$ | $V_{GS} = V_{DS}, I_D = 250\mu A$  | 0.4 |     | 1    | V         |
| Static Drain-Source On-Resistance  | $R_{DS(on)}$ | $V_{GS} = 10V, I_D = 4.8A$   |     | 27  | 34   | $m\Omega$ |
|  |              | $V_{GS} = 4.5V, I_D = 4A$  |     | 28  | 38   | $m\Omega$ |
|  |              | $V_{GS} = 2.5V, I_D = 2A$  |     | 31  | 50   | $m\Omega$ |
|  |              | $V_{GS} = 1.8V, I_D = 1A$  |     | 38  | 60   | $m\Omega$ |
| <b>Dynamic Characteristics <sup>d</sup></b>  |              |  |     |     |      |           |
| Input Capacitance  | $C_{iss}$    | $V_{DS} = 15V, V_{GS} = 0V,$<br>$f = 1.0\text{ MHz}$                     |     | 735 |      | pF        |
| Output Capacitance   | $C_{oss}$    |  |     | 90  |      | pF        |
| Reverse Transfer Capacitance   | $C_{rss}$    |  |     | 65  |      | pF        |
| <b>Switching Characteristics <sup>d</sup></b>  |              |  |     |     |      |           |
| Turn-On Delay Time   | $t_{d(on)}$  | $V_{DD} = 15V, I_D = 4.8A, \square$<br>$V_{GS} = 10V, R_{GEN} = 3\Omega$ |     | 10  | 20   | ns        |
| Turn-On Rise Time  | $t_r$        |  |     | 3   | 6    | ns        |
| Turn-Off Delay Time  | $t_{d(off)}$ |  |     | 40  | 80   | ns        |
| Turn-Off Fall Time   | $t_f$        |  |     | 2   | 4    | ns        |
| Total Gate Charge  | $Q_g$        | $V_{DS} = 15V, I_D = 4.8A,$<br>$V_{GS} = 4.5V$                           |     | 9.0 | 12   | nC        |
| Gate-Source Charge   | $Q_{gs}$     |  |     | 1.0 |      | nC        |
| Gate-Drain Charge  | $Q_{gd}$     |  |     | 2.0 |      | nC        |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b>  |              |  |     |     |      |           |
| Drain-Source Diode Forward Current <sup>b</sup>  | $I_S$        |  |     |     | 1    | A         |
| Drain-Source Diode Forward Voltage <sup>c</sup>  | $V_{SD}$     | $V_{GS} = 0V, I_S = 1A$  |     |     | 1    | V         |
| <b>Notes :</b> $\square$<br>a.Repetitive Rating : Pulse width limited by maximum junction temperature. $\square$<br>b.Surface Mounted on FR4 Board, $t < 5\text{ sec.}$ $\square$<br>c.Pulse Test : Pulse Width $\leq 300\mu s$ , Duty Cycle $\leq 2\%$ . $\square$<br>d.Guaranteed by design, not subject to production testing. $\square$<br>$\square$ |              |  |     |     |      |           |



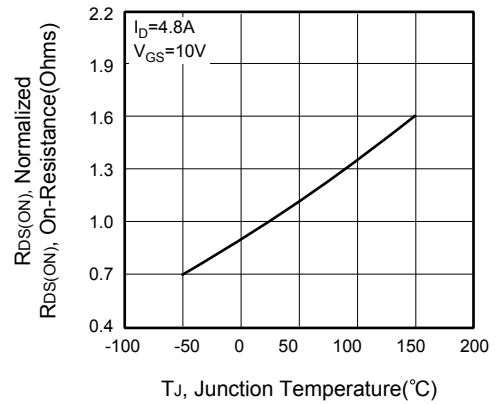
**Figure 1. Output Characteristics**



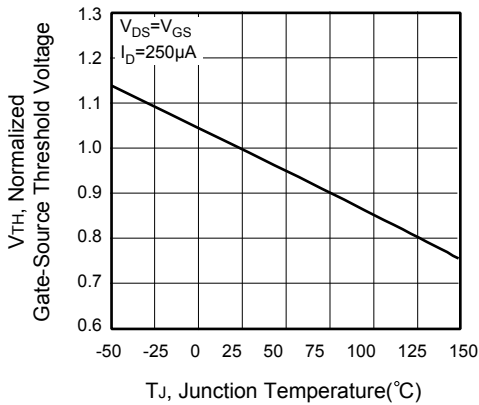
**Figure 2. Transfer Characteristics**



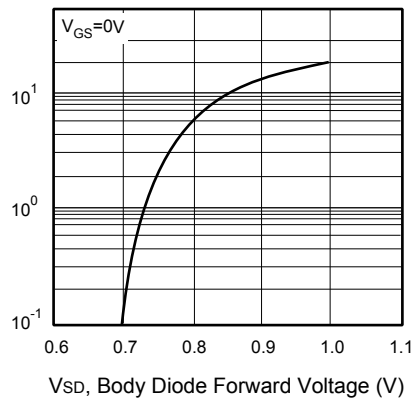
**Figure 3. Capacitance**



**Figure 4. On-Resistance Variation with Temperature**



**Figure 5. Gate Threshold Variation with Temperature**



**Figure 6. Body Diode Forward Voltage Variation with Source Current**

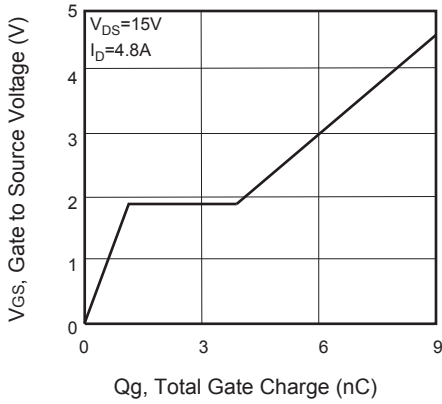


Figure 7. Gate Charge

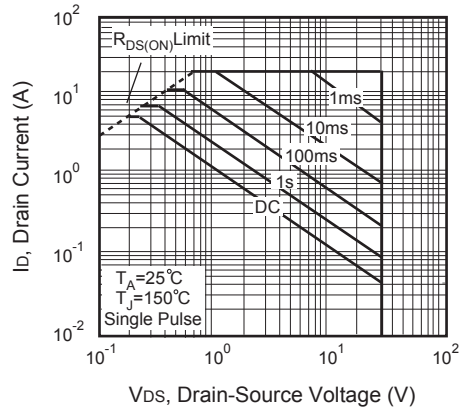


Figure 8. Maximum Safe Operating Area



Figure 9. Switching Test Circuit



Figure 10. Switching Waveforms

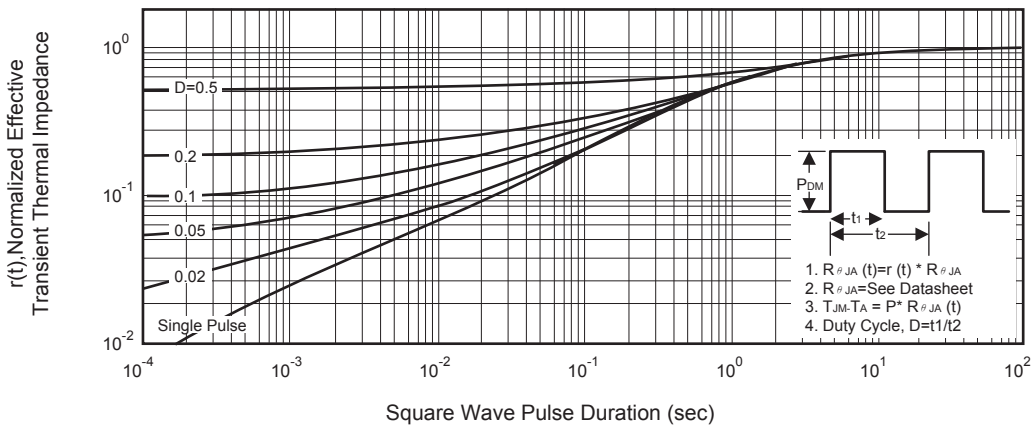


Figure 11. Normalized Thermal Transient Impedance Curve